

# General Purpose Amplifier Transistor

## NPN Silicon Surface Mount

This NPN Silicon Epitaxial Planar Transistor is designed for general purpose amplifier applications. This device is housed in the SC-70/SOT-323 package which is designed for low power surface mount applications.

### Features

- High  $h_{FE}$ , 210–460
- Low  $V_{CE(sat)}$ , < 0.5 V
- Moisture Sensitivity Level 1
- ESD Protection: Human Body Model > 4000 V  
Machine Model > 400 V
- We declare that the material of product compliance with RoHS requirements.

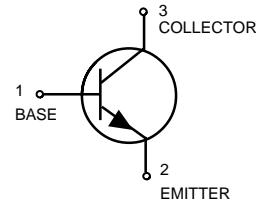
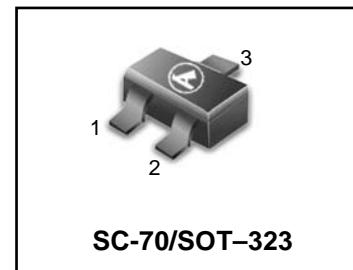
### MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ )

Rating	Symbol	Value	Unit
Collector-Base Voltage	$V_{(BR)CBO}$	60	Vdc
Collector-Emitter Voltage	$V_{(BR)CEO}$	50	Vdc
Emitter-Base Voltage	$V_{(BR)EBO}$	7.0	Vdc
Collector Current – Continuous	$I_C$	100	mAdc
Collector Current – Peak	$I_{C(P)}$	200	mAdc

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Power Dissipation (Note 1)	$P_D$	150	mW
Junction Temperature	$T_J$	150	°C
Storage Temperature Range	$T_{stg}$	-55 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

**LMSD1819A-RT1G**


### Ordering Information

Device	Marking	Shipping
LMSD1819A-RT1G	ZR	3000/Tape&Reel
LMSD1819A-RT1G	ZR	10000/Tape&Reel

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## ELECTRICAL CHARACTERISTICS

Characteristic	Symbol	Min	Max	Unit
Collector-Emitter Breakdown Voltage ( $I_C = 2.0 \text{ mA}_{\text{dc}}, I_B = 0$ )	$V_{(\text{BR})\text{CEO}}$	50	–	Vdc
Collector-Base Breakdown Voltage ( $I_C = 10 \mu\text{A}_{\text{dc}}, I_E = 0$ )	$V_{(\text{BR})\text{CBO}}$	60	–	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 10 \mu\text{A}_{\text{dc}}, I_E = 0$ )	$V_{(\text{BR})\text{EBO}}$	7.0	–	Vdc
Collector-Base Cutoff Current ( $V_{CB} = 20 \text{ Vdc}, I_E = 0$ )	$I_{\text{CBO}}$	–	0.1	$\mu\text{A}$
Collector-Emitter Cutoff Current ( $V_{CE} = 10 \text{ Vdc}, I_B = 0$ )	$I_{\text{CEO}}$	–	0.1	$\mu\text{A}$
DC Current Gain (Note 2) ( $V_{CE} = 10 \text{ Vdc}, I_C = 2.0 \text{ mA}_{\text{dc}}$ ) ( $V_{CE} = 2.0 \text{ Vdc}, I_C = 100 \text{ mA}_{\text{dc}}$ )	$h_{FE1}$ $h_{FE2}$	210 90	340 –	–
Collector-Emitter Saturation Voltage (Note 2) ( $I_C = 100 \text{ mA}_{\text{dc}}, I_B = 10 \mu\text{A}_{\text{dc}}$ )	$V_{CE(\text{sat})}$	–	0.5	Vdc

2. Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , D.C.  $\leq 2\%$ .

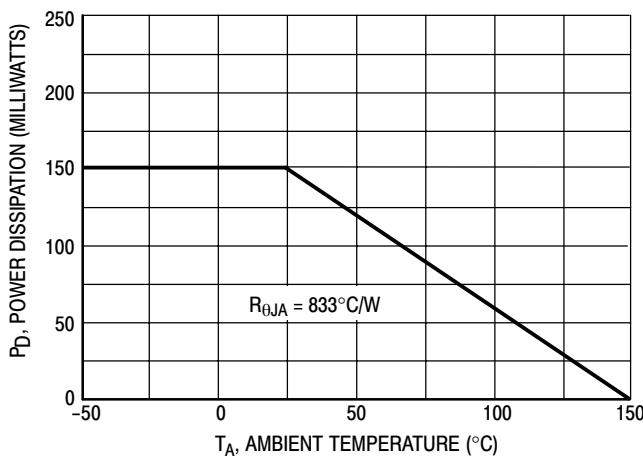


Figure 1. Derating Curve

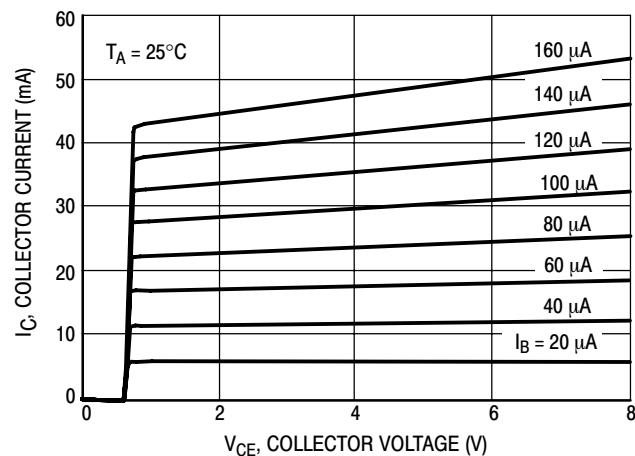


Figure 2. I<sub>C</sub> – V<sub>CE</sub>

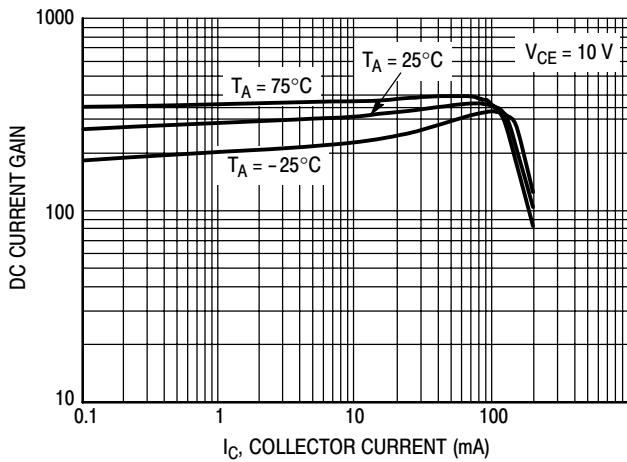


Figure 3. DC Current Gain

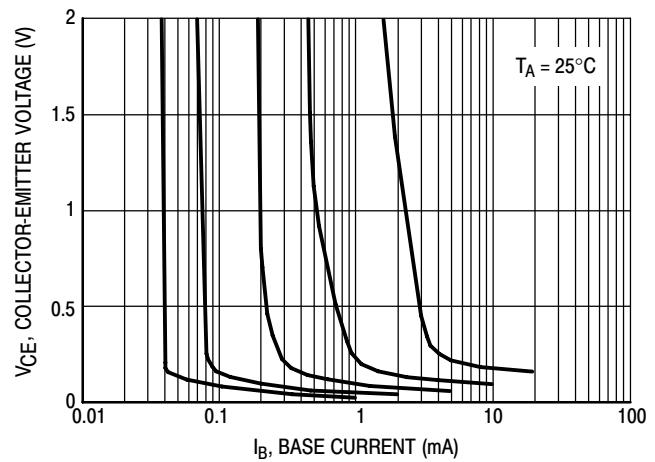
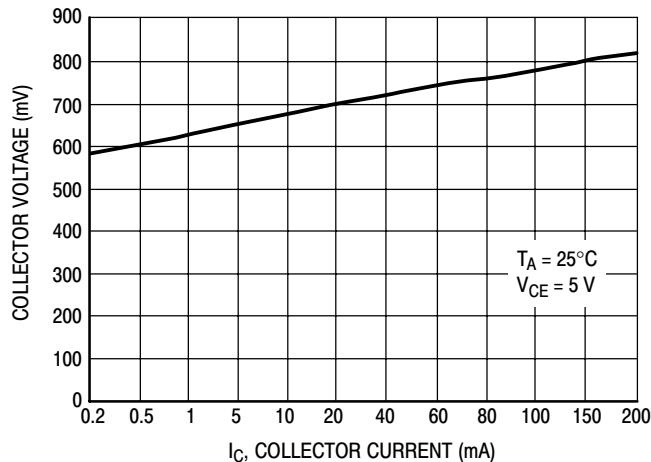
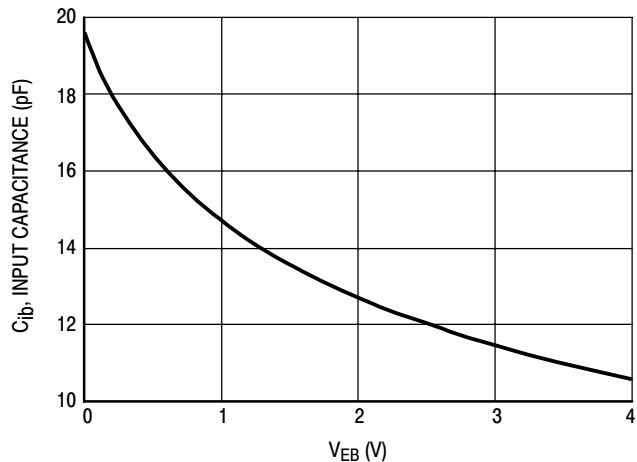


Figure 4. Collector Saturation Region

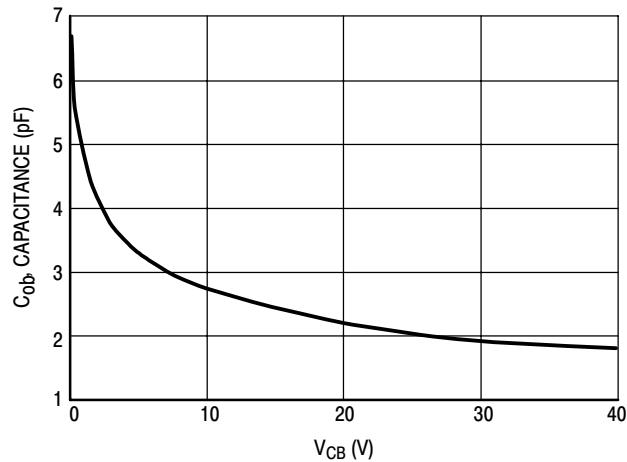
## LMSD1819A-RT1G



**Figure 5. On Voltage**



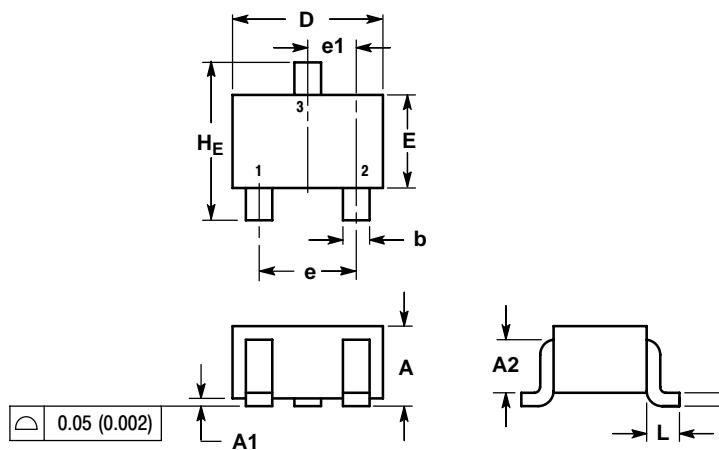
**Figure 6. Capacitance**



**Figure 7. Capacitance**

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## **SC-70 (SOT-323)**



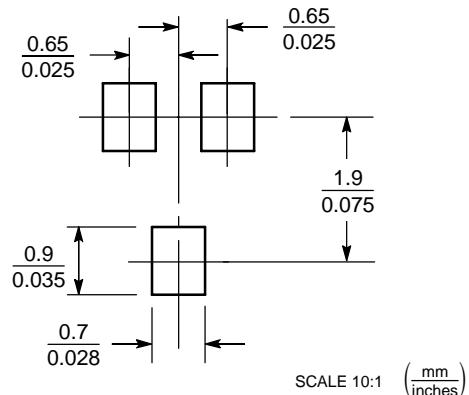
NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2	0.7 REF			0.028 REF		
b	0.30	0.35	0.40	0.012	0.014	0.016
c	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.10	2.20	0.071	0.083	0.087
E	1.15	1.24	1.35	0.045	0.049	0.053
e	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BSC		
L	0.425 REF			0.017 REF		
H <sub>E</sub>	2.00	2.10	2.40	0.079	0.083	0.095

STYLE 3:  
PIN 1. BASE  
2. Emitter  
3. Collector

### **SOLDERING FOOTPRINT\***



SCALE 10:1  $(\frac{\text{mm}}{\text{inches}})$